

NOVELLA

Pilot plant for the coating of components

Combined processes of plasma-activated high-rate evaporation, magnetron sputtering and PECVD

NOVELLA coating system, developed in cooperation with Creavac GmbH



Electron beam source »Easy Beam« developed by Fraunhofer FEP

One area of work at Fraunhofer FEP is the development of technologies for vacuum coating of components that are characterized by non-planar shapes. Fraunhofer FEP applies its expertise in electron beam technology to the field of component coating. In our pilot plant NOVELLA we have implemented the necessary technological facilities: an electron-beam source that enables coating at very high deposition rates, two hollow-cathode plasma sources for plasma generation and vapor activation, and optional a sputter magnetron.

A versatile component transport system provides variable sequences of motion, such as those for depositing multiple layers on 3-dimensional substrates. With this equipment, component coating gains access to productive processes beyond the industrially established techniques like arc evaporation and magnetron sputtering.

The device can be used for physical vapor deposition (PVD) as well as plasma-enhanced chemical vapor deposition (PECVD) and combined processes. We have thus a powerful tool to develop optimized coatings that can meet increasingly demanding requirements. Among these are specific properties for wear and corrosion protection, electrical conductivity, magnetic shielding, and decorative effects of components.

An effective plasma-based pre-treatment is an essential step in all coating processes. Furthermore, plasma activation enables the structure of the deposited layers to be influenced in a controlled manner. This makes the deposition of dense, compact layers feasible even at coating rates of up to several microns per minute. The prototype NOVELLA system enables us to demonstrate extremely productive short-cycle processes at very high coating rates as a preliminary step for implementation of these processes in industrial production lines.

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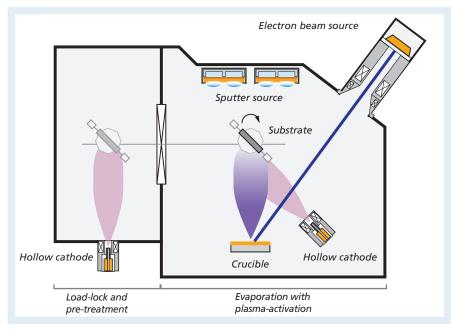
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Technical specifications

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Substrate	 Diameter up to 150 mm
	 Length up to 300 mm
	 Weight up to 15 kg
Substrate movement	 Rotation up to 100 U/min
	 Translation up to 10 m/min
Two-chamber unit	Load-lock chamber including substrate pre-treatment
	Coating chamber
Pre-treatment	 Sputter-etching
	 Heating (up to 600°C)
Hollow cathode plasma source	 Power supply 30kW, 200A
	 Plasma density: 10¹⁸/m³
	 Argon-ion-current density: 40 mA/cm²
Sputter source	 Planar double magnetron
	 Power supply max. 60 kW, pulse rate max. 50 kHz
Electron beam source	 Plasma-based gun 120 kW/40 kV
Evaporation crucible	Water-cooled copper crucible
	Hot ceramic crucible
	• Special forms (rotatable crucible, crucible with rod feeding,
	multiple material evaporation)



Scheme of NOVELLA



We focus on quality and the ISO 9001.



Technologies

- Plasma-activated high-rate deposition
- Hollow cathode PECVD
- Pulse magnetron sputtering
- Hollow cathode-enhanced sputter-etching

Layer materials

- Metals
- Alloys
- Oxides
- Nitrides
- Carbon-based layers
- Further composite layers

Our offer

- Feasibility studies
- Coating development
- Process development
- Technology development
- Coating of samples
- Delivery of key components



Funded by the European Union and the Free State of Saxony. Funding reference: 100146071

- 1 Hollow cathode arc discharge
- **2** Double magnetron in pulsed operation